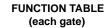
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 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

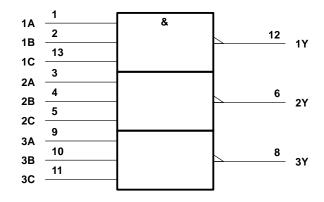
These devices contain three independent 3-input positive-NAND gates. They perform the Boolean functions $Y = \overline{A \cdot B \cdot C}$ or $Y = \overline{A} + \overline{B} + \overline{C}$ in positive logic.

The SN54ALS10A and SN54AS10 are characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ALS10A and SN74AS10 are characterized for operation from 0°C to 70°C.



	INPUTS		OUTPUT
Α	В	С	Y
Н	Н	Н	L
L	Х	Х	н
Х	L	Х	н
Х	Х	L	н

logic symbol[†]



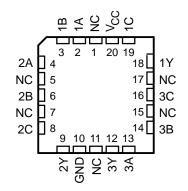
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

SN54ALS10A, SN54AS10 ... J PACKAGE SN74ALS10A, SN74AS10 ... D OR N PACKAGE (TOP VIEW)

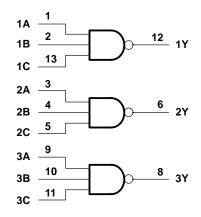
	(10)		
1A 1B 2A 2B 2C 2Y GND	[] 3 [] 4	14 13 12 11 10 9 8] V _{CC}] 1C] 1Y] 3C] 3B] 3A] 3Y

SN54ALS10A, SN54AS10...FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram (positive logic)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	
Operating free-air temperature range, T _A : SN54ALS10A	
SN74ALS10A	0°C to 70°C
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54ALS10A		SN74ALS10A			UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
N/				0.8‡			0.8	V
VIL	Low-level input voltage			0.7§				v
ЮН	High-level output current			-0.4			-0.4	mA
IOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	-55		125	0		70	°C

[‡] Applies over temperature range –55°C to 70°C

§ Applies over temperature range 70°C to 125°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TERTO		SN	54ALS1)A	SN	74ALS1	0A	UNIT
PARAMETER	TEST CONDITIONS		MIN	TYP¶	MAX	MIN	TYP¶	MAX	UNIT
VIK	V _{CC} = 4.5 V,	l _l = –18 mA			-1.5			-1.5	V
VOH	V_{CC} = 4.5 V to 5.5 V,	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2			V _{CC} -2	2		V
VoL	V _{CC} = 4.5 V	I _{OL} = 4 mA	0.25	0.25	0.4	0.25		0.4	V
VOL	VCC = 4.5 V	I _{OL} = 8 mA					0.35	0.5	v
lı	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
Чн	V _{CC} = 5.5 V,	VI = 2.7 V			20			20	μA
١ _{١L}	V _{CC} = 5.5 V,	VI = 0.4 V			-0.1			-0.1	mA
IO [#]	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
Іссн	V _{CC} = 5.5 V,	V _I = 0		0.32	0.6		0.32	0.6	mA
ICCL	V _{CC} = 5.5 V,	V _I = 4.5 V		1.2	2.2		1.2	2.2	mA

¶ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[#] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.



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switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _C C _L R _L T _A	UNIT			
			SN54A	LS10A	SN74A	LS10A	
			MIN	MAX	MIN	MAX	
^t PLH	A, B, or C	v	2	12	2	11	ns
^t PHL	7, 5, 6, 6	' '	2	12	2	10	115

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage, V _{CC}	
Operating free-air temperature range, T _A : SN54AS10	–55°C to 125°C
SN74AS10	0°C to 70°C
Storage temperature range	-65°C to 150°C

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS10		S	UNIT			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
ЮН	High-level output current			-2			-2	mA
IOL	Low-level output current			20			20	mA
Т _А	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CO	TEST CONDITIONS			SN54AS10		SN74AS10		
PARAMETER	TER TEST CONDITIONS		MIN	MIN TYP§ MAX		MIN	ΤΥΡ§	MAX	UNIT
VIK	V _{CC} = 4.5 V,	l _l = –18 mA			-1.2			-1.2	V
VOH	V_{CC} = 4.5 V to 5.5 V,	I _{OH} = -2 mA	V _{CC} -2	2		V _{CC} -2	2		V
VOL	V _{CC} = 4.5 V,	I _{OL} = 20 mA		0.35	0.5		0.35	0.5	V
lj	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
ЧΗ	V _{CC} = 5.5 V,	VI = 2.7 V			20			20	μA
١ _{IL}	V _{CC} = 5.5 V,	VI = 0.4 V			-0.5			-0.5	mA
۱ _О ¶	V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	-30		-112	mA
ІССН	V _{CC} = 5.5 V,	$V_{I} = 0$		1.5	2.4		1.5	2.4	mA
ICCL	V _{CC} = 5.5 V,	V _I = 4.5 V		8.1	13		8.1	13	mA

§ All typical values are at V_{CC} = 5 V, T_A = 25° C.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

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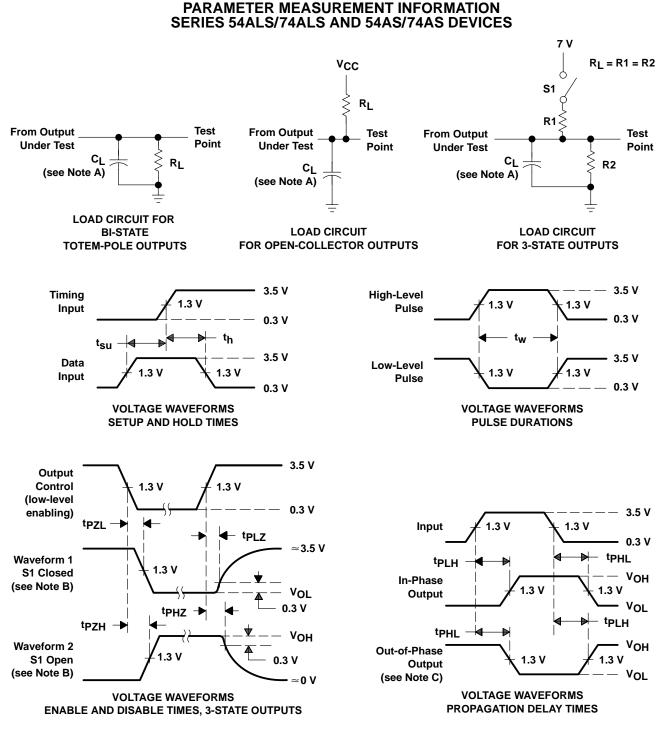
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	то (оитрит)	V _C CL RL TA	UNIT			
			SN54	AS10	SN74/	AS10	
			MIN	MAX	MIN	MAX	
^t PLH	A, B, or C	v	1	5	1	4.5	ns
^t PHL		1	1	5	1	4.5	115

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

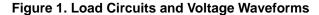


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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.





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